

MC74HC165A

8-Bit Serial or Parallel-Input/ Serial-Output Shift Register High-Performance Silicon-Gate CMOS

The MC74HC165A is identical in pinout to the LS165. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

This device is an 8-bit shift register with complementary outputs from the last stage. Data may be loaded into the register either in parallel or in serial form. When the Serial Shift/Parallel Load input is low, the data is loaded asynchronously in parallel. When the Serial Shift/Parallel Load input is high, the data is loaded serially on the rising edge of either Clock or Clock Inhibit (see the Function Table).

The 2-input NOR clock may be used either by combining two independent clock sources or by designating one of the clock inputs to act as a clock inhibit.

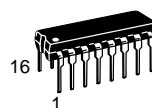
- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: 1 μ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 286 FETs or 71.5 Equivalent Gates



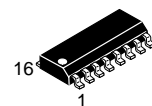
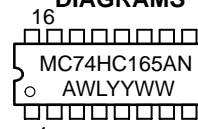
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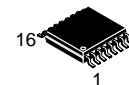
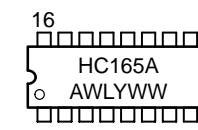
MARKING DIAGRAMS



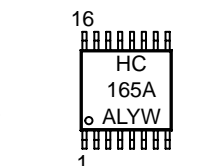
PDIP-16
N SUFFIX
CASE 648



SO-16
D SUFFIX
CASE 751B



TSSOP-16
DT SUFFIX
CASE 948F

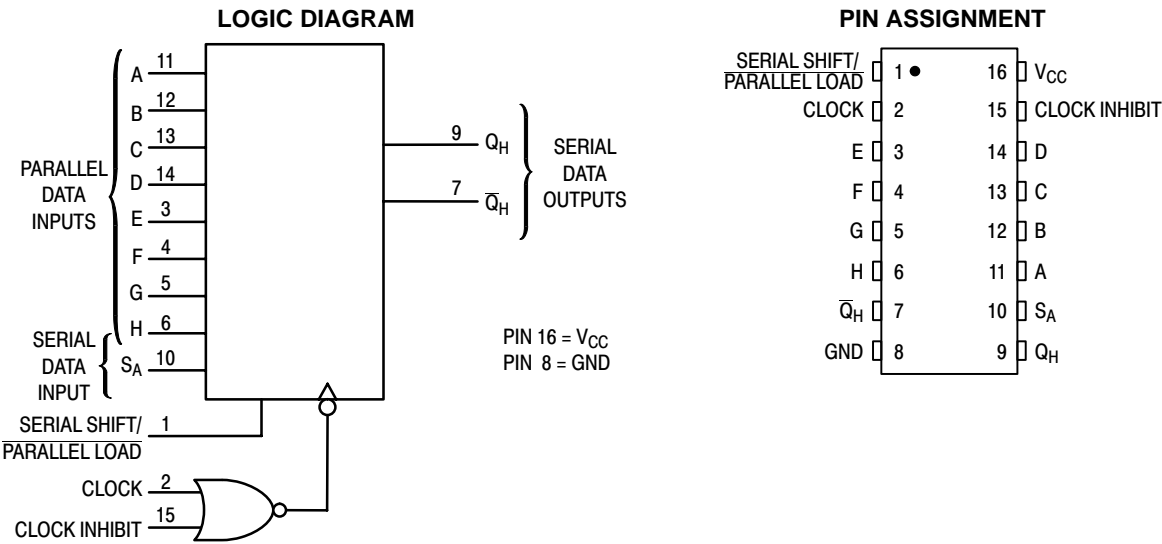


A = Assembly Location
WL or L = Wafer Lot
YY or Y = Year
WW or W = Work Week





ORDERING INFORMATION

| Device | Package | Shipping |
|----------------|----------|-------------|
| MC74HC165AN | PDIP-16 | 2000 / Box |
| MC74HC165AD | SOIC-16 | 48 / Rail |
| MC74HC165ADR2 | SOIC-16 | 2500 / Reel |
| MC74HC165ADT | TSSOP-16 | 96 / Rail |
| MC74HC165ADTR2 | TSSOP-16 | 2500 / Reel |

MC74HC165A



FUNCTION TABLE

| Inputs | | | | | Internal Stages | | Output | |
|--------------------------------|---|---|----------------|---------|-----------------|-----------------|-----------------|--------------------------------|
| Serial Shift/ Parallel Load | Clock | Clock Inhibit | S _A | A – H | | | | |
| L | X | X | X | a ... h | a | b | h | Asynchronous Parallel Load |
| H |  | L | L | X | L | Q _{An} | Q _{Gn} | Serial Shift via Clock |
| H |  | L | H | X | H | Q _{An} | Q _{Gn} | |
| H | L |  | L | X | L | Q _{An} | Q _{Gn} | Serial Shift via Clock Inhibit |
| H | L |  | H | X | H | Q _{An} | Q _{Gn} | |
| H | X | H | X | X | No Change | | | Inhibited Clock |
| H | H | X | X | X | No Change | | | |
| H | L | L | X | X | No Change | | | No Clock |

X = don't care Q_{An} – Q_{Gn} = Data shifted from the preceding stage

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MAXIMUM RATINGS*

| Symbol | Parameter | Value | Unit |
|-----------|---|-------------------------|------|
| V_{CC} | DC Supply Voltage (Referenced to GND) | – 0.5 to + 7.0 | V |
| V_{in} | DC Input Voltage (Referenced to GND) | – 0.5 to $V_{CC} + 0.5$ | V |
| V_{out} | DC Output Voltage (Referenced to GND) | – 0.5 to $V_{CC} + 0.5$ | V |
| I_{in} | DC Input Current, per Pin | ± 20 | mA |
| I_{out} | DC Output Current, per Pin | ± 25 | mA |
| I_{CC} | DC Supply Current, V_{CC} and GND Pins | ± 50 | mA |
| P_D | Power Dissipation in Still Air Plastic DIP† SOIC Package† TSSOP Package† | 750 500 450 | mW |
| T_{stg} | Storage Temperature | – 65 to + 150 | °C |
| T_L | Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP, SOIC or TSSOP Package) | 260 | °C |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

*Maximum Ratings are those values beyond which damage to the device may occur.

Functional operation should be restricted to the Recommended Operating Conditions.

†Derating — Plastic DIP: – 10 mW/°C from 65° to 125°C

SOIC Package: – 7 mW/°C from 65° to 125°C

TSSOP Package: – 6.1 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 2 of the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|------------------------------------|--|--|--------------------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | 2.0 | 6.0 | V |
| V _{in} , V _{out} | DC Input Voltage, Output Voltage (Referenced to GND) | 0 | V _{CC} | V |
| T _A | Operating Temperature, All Package Types | − 55 | + 125 | °C |
| t _r , t _f | Input Rise and Fall Time (Figure 1) | V _{CC} = 2.0 V V _{CC} = 3.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V | 0 1000 600 500 400 | ns |

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol | Parameter | Test Conditions | V_{CC} V | Guaranteed Limit | | | Unit |
|----------|-----------------------------------|---|--------------------------|----------------------------|----------------------------|----------------------------|------|
| | | | | – 55 to 25°C | ≤ 85°C | ≤ 125°C | |
| V_{IH} | Minimum High-Level Input Voltage | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 3.0 4.5 6.0 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | V |
| V_{IL} | Maximum Low-Level Input Voltage | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 3.0 4.5 6.0 | 0.5 0.9 1.35 1.80 | 0.5 0.9 1.35 1.80 | 0.5 0.9 1.35 1.80 | V |
| V_{OH} | Minimum High-Level Output Voltage | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 4.5 6.0 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | V |
| | | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \leq 2.4 \text{ mA}$ $ I_{out} \leq 4.0 \text{ mA}$ $ I_{out} \leq 5.2 \text{ mA}$ | 3.0 4.5 6.0 | 2.48 3.98 5.48 | 2.34 3.84 5.34 | 2.20 3.70 5.20 | V |

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DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol | Parameter | Test Conditions | V _{CC} V | Guaranteed Limit | | | Unit |
|-----------------|--|--|----------------------|------------------|--------|---------|------|
| | | | | – 55 to 25°C | ≤ 85°C | ≤ 125°C | |
| V _{OL} | Maximum Low-Level Output Voltage | V _{in} = V _{IH} or V _{IL} I _{out} ≤ 20 μA | 2.0 | 0.1 | 0.1 | 0.1 | V |
| | | | 4.5 | 0.1 | 0.1 | 0.1 | |
| | | | 6.0 | 0.1 | 0.1 | 0.1 | |
| | | V _{in} = V _{IH} or V _{IL} I _{out} ≤ 2.4 mA I _{out} ≤ 4.0 mA I _{out} ≤ 5.2 mA | 3.0 | 0.26 | 0.33 | 0.40 | |
| | | | 4.5 | 0.26 | 0.33 | 0.40 | |
| | | | 6.0 | 0.26 | 0.33 | 0.40 | |
| I _{in} | Maximum Input Leakage Current | V _{in} = V _{CC} or GND | 6.0 | ± 0.1 | ± 1.0 | ± 1.0 | μA |
| I _{CC} | Maximum Quiescent Supply Current (per Package) | V _{in} = V _{CC} or GND I _{out} = 0 μA | 6.0 | 4 | 40 | 160 | μA |

NOTE: Information on typical parametric values can be found in Chapter 2 of the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

AC ELECTRICAL CHARACTERISTICS (C_L = 50 pF, Input t_r = t_f = 6 ns)

| Symbol | Parameter | V _{CC} V | Guaranteed Limit | | | Unit |
|--|--|----------------------|------------------|--------|---------|------|
| | | | – 55 to 25°C | ≤ 85°C | ≤ 125°C | |
| f _{max} | Maximum Clock Frequency (50% Duty Cycle) (Figures 1 and 8) | 2.0 | 6 | 4.8 | 4 | MHz |
| | | 3.0 | 18 | 17 | 15 | |
| | | 4.5 | 30 | 24 | 20 | |
| | | 6.0 | 35 | 28 | 24 | |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, Clock (or Clock Inhibit) to Q _H or \overline{Q}_H (Figures 1 and 8) | 2.0 | 150 | 190 | 225 | ns |
| | | 3.0 | 52 | 63 | 65 | |
| | | 4.5 | 30 | 38 | 45 | |
| | | 6.0 | 26 | 33 | 38 | |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, Serial Shift/Parallel Load to Q _H or \overline{Q}_H (Figures 2 and 8) | 2.0 | 175 | 220 | 265 | ns |
| | | 3.0 | 58 | 70 | 72 | |
| | | 4.5 | 35 | 44 | 53 | |
| | | 6.0 | 30 | 37 | 45 | |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, Input H to Q _H or \overline{Q}_H (Figures 3 and 8) | 2.0 | 150 | 190 | 225 | ns |
| | | 3.0 | 52 | 63 | 65 | |
| | | 4.5 | 30 | 38 | 45 | |
| | | 6.0 | 26 | 33 | 38 | |
| t _{TLH} , t _{THL} | Maximum Output Transition Time, Any Output (Figures 1 and 8) | 2.0 | 75 | 95 | 110 | ns |
| | | 3.0 | 27 | 32 | 36 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| C _{in} | Maximum Input Capacitance | — | 10 | 10 | 10 | pF |

NOTES:

1. For propagation delays with loads other than 50 pF, see Chapter 2 of the ON Semiconductor High-Speed CMOS Data Book (DL129/D).
2. Information on typical parametric values can be found in Chapter 2 of the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

| C _{PD} | Power Dissipation Capacitance (Per Package)* | Typical @ 25°C, V _{CC} = 5.0 V | pF |
|-----------------|--|---|----|
| | | 40 | |

* Used to determine the no-load dynamic power consumption: P_D = C_{PD} V_{CC}²f + I_{CC} V_{CC}. For load considerations, see Chapter 2 of the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

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TIMING REQUIREMENTS (Input $t_r = t_f = 6$ ns)

| Symbol | Parameter | V _{CC} V | Guaranteed Limit | | | Unit |
|---------------------------------|--|----------------------|------------------|--------|---------|------|
| | | | – 55 to 25°C | ≤ 85°C | ≤ 125°C | |
| t _{su} | Minimum Setup Time, Parallel Data Inputs to Serial Shift/Parallel Load (Figure 4) | 2.0 | 75 | 95 | 110 | ns |
| | | 3.0 | 30 | 40 | 55 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _{su} | Minimum Setup Time, Input SA to Clock (or Clock Inhibit) (Figure 5) | 2.0 | 75 | 95 | 110 | ns |
| | | 3.0 | 30 | 40 | 55 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _{su} | Minimum Setup Time, Serial Shift/Parallel Load to Clock (or Clock Inhibit) (Figure 6) | 2.0 | 75 | 95 | 110 | ns |
| | | 3.0 | 30 | 40 | 55 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _{su} | Minimum Setup Time, Clock to Clock Inhibit (Figure 7) | 2.0 | 75 | 95 | 110 | ns |
| | | 3.0 | 30 | 40 | 55 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _h | Minimum Hold Time, Serial Shift/Parallel Load to Parallel Data Inputs (Figure 4) | 2.0 | 5 | 5 | 5 | ns |
| | | 3.0 | 5 | 5 | 5 | |
| | | 4.5 | 5 | 5 | 5 | |
| | | 6.0 | 5 | 5 | 5 | |
| t _h | Minimum Hold Time, Clock (or Clock Inhibit) to Input SA (Figure 5) | 2.0 | 5 | 5 | 5 | ns |
| | | 3.0 | 5 | 5 | 5 | |
| | | 4.5 | 5 | 5 | 5 | |
| | | 6.0 | 5 | 5 | 5 | |
| t _h | Minimum Hold Time, Clock (or Clock Inhibit) to Serial Shift/Parallel Load (Figure 6) | 2.0 | 5 | 5 | 5 | ns |
| | | 3.0 | 5 | 5 | 5 | |
| | | 4.5 | 5 | 5 | 5 | |
| | | 6.0 | 5 | 5 | 5 | |
| t _{rec} | Minimum Recovery Time, Clock to Clock Inhibit (Figure 7) | 2.0 | 75 | 95 | 110 | ns |
| | | 3.0 | 30 | 40 | 55 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _w | Minimum Pulse Width, Clock (or Clock Inhibit) (Figure 1) | 2.0 | 70 | 90 | 100 | ns |
| | | 3.0 | 27 | 32 | 36 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _w | Minimum Pulse width, Serial Shift/Parallel Load (Figure 2) | 2.0 | 70 | 90 | 100 | ns |
| | | 3.0 | 27 | 32 | 36 | |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| t _r , t _f | Maximum Input Rise and Fall Times (Figure 1) | 2.0 | 1000 | 1000 | 1000 | ns |
| | | 3.0 | 800 | 800 | 800 | |
| | | 4.5 | 500 | 500 | 500 | |
| | | 6.0 | 400 | 400 | 400 | |

NOTE: Information on typical parametric values can be found in Chapter 2 of the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

PIN DESCRIPTIONS**INPUTS****A, B, C, D, E, F, G, H (Pins 11, 12, 13, 14, 3, 4, 5, 6)**

Parallel Data inputs. Data on these inputs are asynchronously entered in parallel into the internal flip-flops when the Serial Shift/Parallel Load input is low.

SA (Pin 10)

Serial Data input. When the Serial Shift/Parallel Load input is high, data on this pin is serially entered into the first stage of the shift register with the rising edge of the Clock.

CONTROL INPUTS**Serial Shift/Parallel Load (Pin 1)**

Data-entry control input. When a high level is applied to this pin, data at the Serial Data input (SA) are shifted into the register with the rising edge of the Clock. When a low level

is applied to this pin, data at the Parallel Data inputs are asynchronously loaded into each of the eight internal stages.

Clock, Clock Inhibit (Pins 2, 15)

Clock inputs. These two clock inputs function identically. Either may be used as an active-high clock inhibit. However, to avoid double clocking, the inhibit input should go high only while the clock input is high.

The shift register is completely static, allowing Clock rates down to DC in a continuous or intermittent mode.

OUTPUTS**Q_H, \overline{Q}_H (Pins 9, 7)**

Complementary Shift Register outputs. These pins are the noninverted and inverted outputs of the eighth stage of the shift register.

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SWITCHING WAVEFORMS

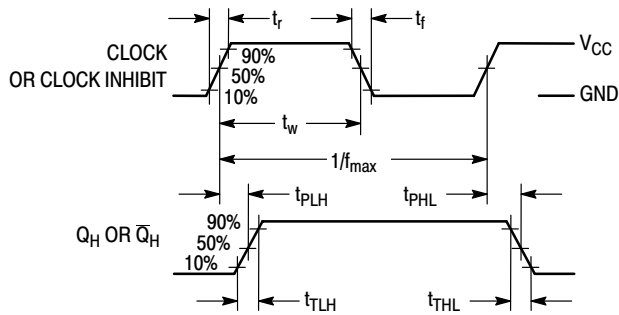


Figure 1. Serial-Shift Mode

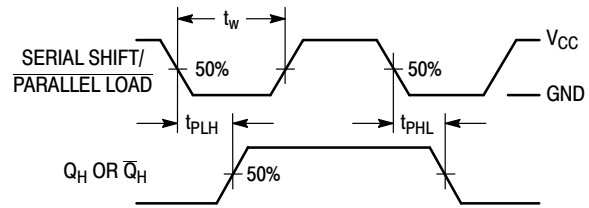


Figure 2. Parallel-Load Mode

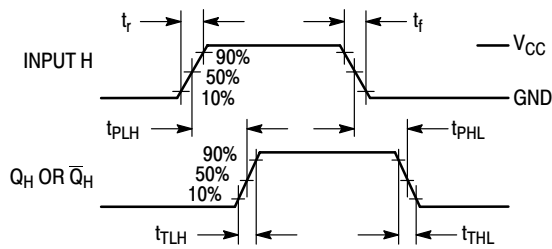


Figure 3. Parallel-Load Mode

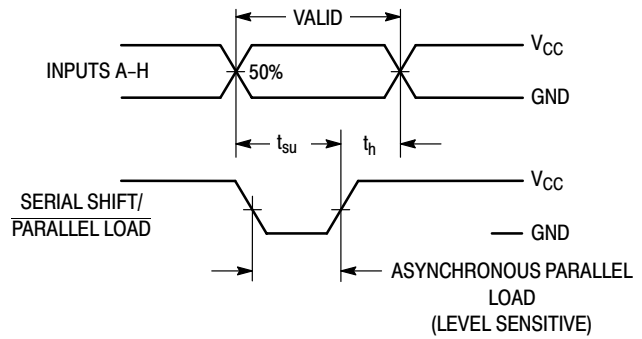


Figure 4. Parallel-Load Mode

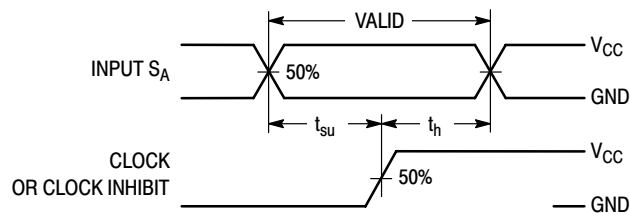


Figure 5. Serial-Shift Mode

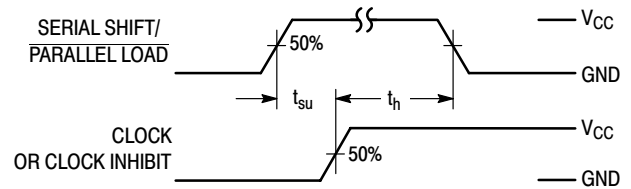


Figure 6. Serial-Shift Mode

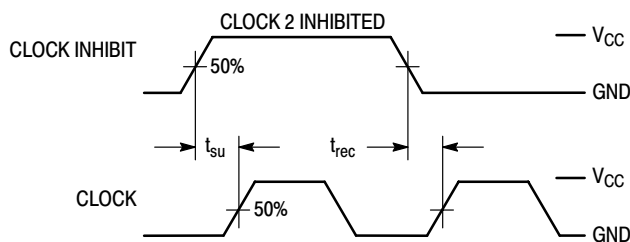
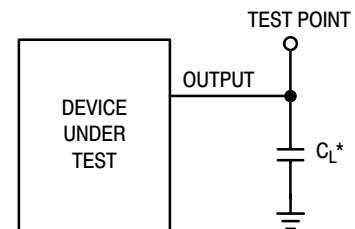


Figure 7. Serial-Shift, Clock-Inhibit Mode

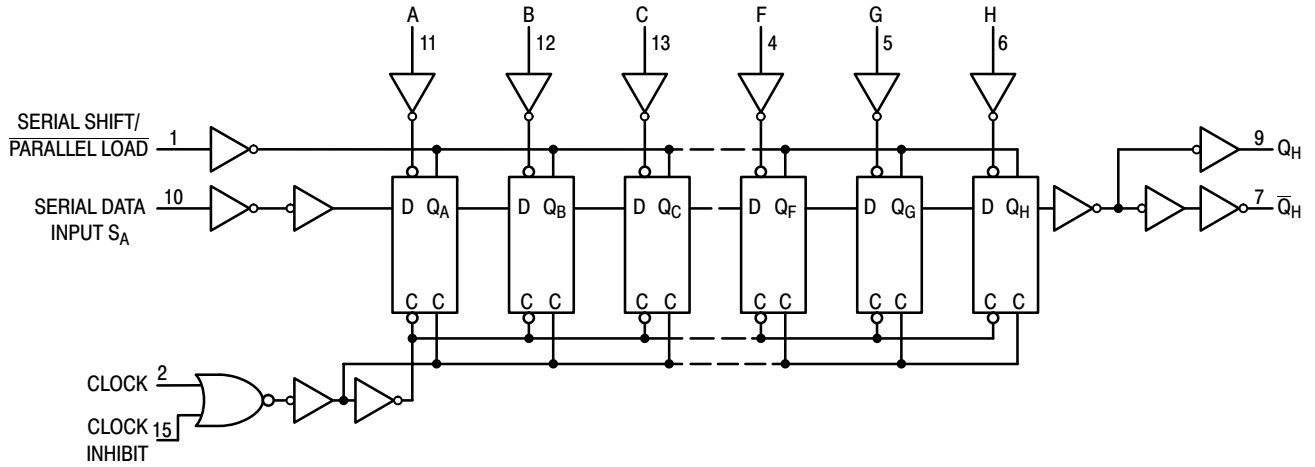


*Includes all probe and jig capacitance

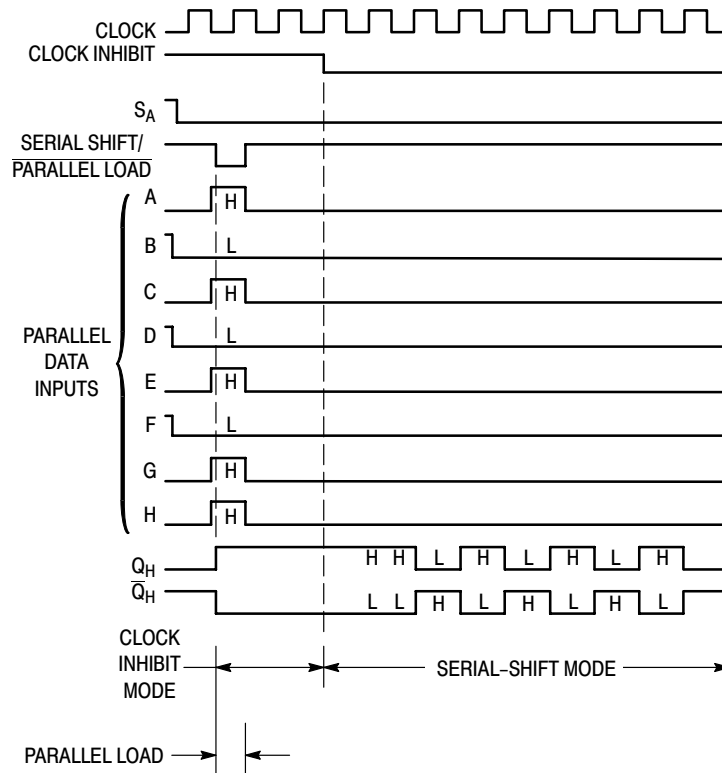
Figure 8. Test Circuit

MC74HC165A

EXPANDED LOGIC DIAGRAM



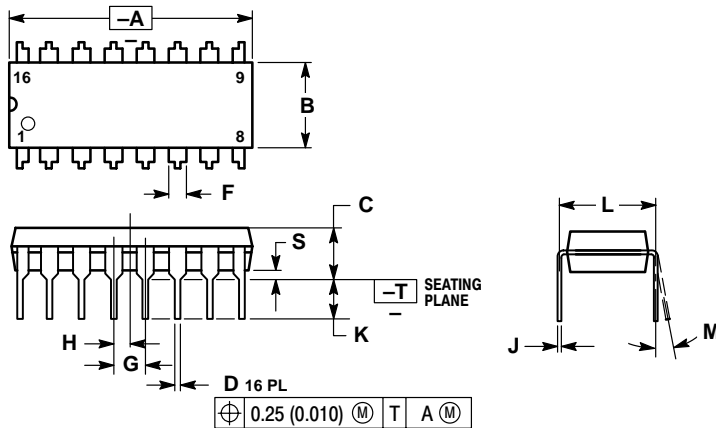
TIMING DIAGRAM



MC74HC165A

PACKAGE DIMENSIONS

PDIP-16
N SUFFIX
CASE 648-08
ISSUE R

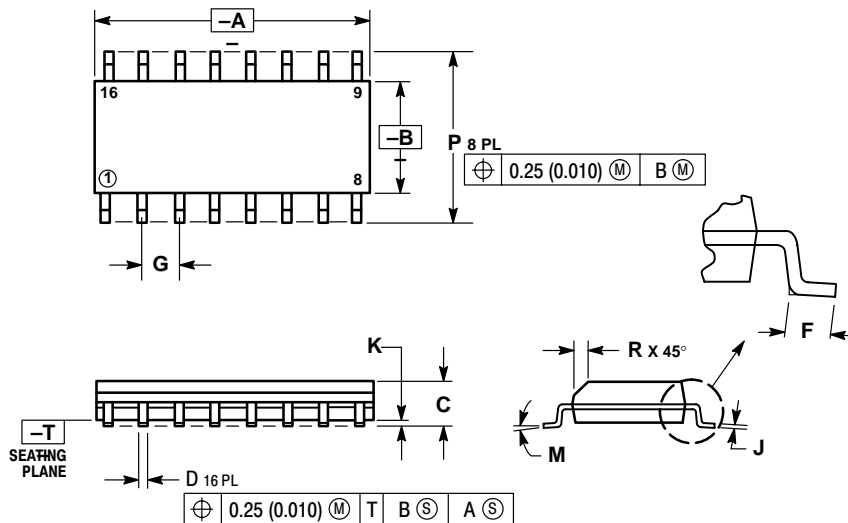


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.740 | 0.770 | 18.80 | 19.55 |
| B | 0.250 | 0.270 | 6.35 | 6.85 |
| C | 0.145 | 0.175 | 3.69 | 4.44 |
| D | 0.015 | 0.021 | 0.39 | 0.53 |
| F | 0.040 | 0.070 | 1.02 | 1.77 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.050 BSC | | 1.27 BSC | |
| J | 0.008 | 0.015 | 0.21 | 0.38 |
| K | 0.110 | 0.130 | 2.80 | 3.30 |
| L | 0.295 | 0.305 | 7.50 | 7.74 |
| M | 0° | 10° | 0° | 10° |
| S | 0.020 | 0.040 | 0.51 | 1.01 |

SOIC-16
D SUFFIX
CASE 751B-05
ISSUE J




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 9.80 | 10.00 | 0.386 | 0.393 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.054 | 0.068 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.40 | 1.25 | 0.016 | 0.049 |
| G | 1.27 BSC | | 0.050 BSC | |
| J | 0.19 | 0.25 | 0.008 | 0.009 |
| K | 0.10 | 0.25 | 0.004 | 0.009 |
| M | 0° | 7° | 0° | 7° |
| P | 5.80 | 6.20 | 0.229 | 0.244 |
| R | 0.25 | 0.50 | 0.010 | 0.019 |

Notes

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